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Amendments to the Claims

This listing of the claims will replace all prior versions:

Listing of claims:

1. (currently amended) A method for repairing a damaged area in a mica an insulation material comprising:

formulating a patching resin with improved wetting properties comprising a resinous composition, metal intercalated AlSiO nano structures, and a reactive diluent, wherein the ratio of said metal intercalated AlSiO nano structures to said resinous composition and said reactive diluent is between 3-35 % wt;

applying said patching resin to said damaged area; and curing said patching resin to produce a patch;

wherein the viscosity of said patching resin is between 100-300 cps; and

wherein said metal intercalated AlSiO nano structures penetrate said damaged area of said mica insulation material creating a substantially homogenous transition between said damaged area and said patch.

- 2. (Previously Presented) The method of claim 1, wherein the ratio of said metal intercalated AlSiO nano structures to said resinous composition and said reactive diluent is between 5-10 % wt.
- 3. (Previously Presented) The method of claim 1, wherein the curing of said patching resin is performed locally on said damaged area.
- 4. (Previously Presented) The method of claim 1, wherein the temperature of the curing of said patching resins is between about 60-120 °C.
- 5. (Previously Presented) The method of claim 1, wherein the temperature of the curing of said patching resins is approximately 90 °C.

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- 6. (Previously Presented) The method of claim 1, wherein the metal in said metal intercalated AlSiO nano structures is one of Cr, Sn, Zn and mixtures thereof.
- 7. (Previously Presented) The method of claim 1, wherein the AlSiO nano structures in said metal intercalated AlSiO nano structures are nanoclays.
- 8. (Previously Presented) The method of claim 1, wherein said resinous composition is bisphenol F.
- 9. (Previously Presented) The method of claim 1, wherein said reactive diluent is at least one of DGENPG, DGEBD and mixtures thereof.
- 10. (Previously Presented) The method of claim 1, wherein the viscosity of said patching resin is between 120-175 cps.
- 11. (currently amended) A method for repairing a damaged area in a mica insulation material comprising:

formulating a patching resin with improved wetting properties comprising a resinous composition, metal intercalated AlSiO nano structures, and a reactive diluent, wherein the ratio of said metal intercalated AlSiO nano structures to said resinous composition and said reactive diluent is between 3-35 % wt;

applying said patching resin to said damaged area; and

curing said patching resin with a localized heat on said damaged area of between 60-120 °C:

wherein said metal intercalated AlSiO nano structures are substantially free of solvent when formulating said patching resin;

wherein the viscosity of said patching resin is between 100-300 cps;

wherein said metal intercalated AlSiO nano structures penetrate said damaged area of said mica insulation material creating a substantially homogenous transition between said damaged area and said patch;

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wherein the metal in said metal intercalated AlSiO nano structures is one of Cr, Sn, Zn and mixtures thereof.

12. (currently amended) A method of thickening an insulating tape comprising formulating a patching resin with improved wetting properties comprising a resinous composition, metal intercalated AlSiO nano structures, and a reactive diluent, wherein the ratio of said metal intercalated AlSiO nano structures to said resinous composition and said reactive diluent is between 3-35 % wt;

applying said patching resin to said insulating tape; and euring said patching resin to produce a patch;

wherein the viscosity of said patching resin is between 100-300 cps;

wherein said metal intercalated AlSiO nano structures penetrate said insulating tape creating a substantially homogenous transition between said insulating tape and said patching resin; and

curing said patching resin to produce a thicker insulating tape.

- 13. (Previously Presented) The method of claim 12, wherein the ratio of said metal intercalated AlSiO nano structures to said resinous composition and said reactive diluent is between 5-10 % wt.
- 14. (Previously Presented) The method of claim 12, wherein the curing of said patching resin is performed locally on said damaged area
- 15. (Previously Presented) The method of claim 12, wherein the temperature of the curing of said patching resins is between about 60-120 °C.
- 16. (Previously Presented) The method of claim 12, wherein the metal in said metal intercalated AlSiO nano structures is one of Cr, Sn, Zn and mixtures thereof.

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- 17. (Previously Presented) The method of claim 12, wherein the AlSiO nano structures in said metal intercalated AlSiO nano structures are nanoclays.
- 18. (Previously Presented) The method of claim 12, wherein said resinous composition is bisphenol F.
- 19. (Previously Presented) The method of claim 12, wherein said reactive diluent is at least one of DGENPG, DGEBD and mixtures thereof.
- 20. (Previously Presented) The method of claim 12, wherein the viscosity of said patching resin is between 120-175 cps
- 21. (Previously Presented) The method of claim 12, wherein said metal intercalated AlSiO nano structures are substantially free of solvent when formulating said patching resin.